

Sauls Wharf House Crittens Road Great Yarmouth Norfolk NR31 0AG

| MD128128A6W-FPTLW 128 x 128 | | LCD Module | | | |
|-----------------------------|--------------------------|------------------|--|--|--|
| Specification | | | | | |
| Version: 1 | | Date: 23/10/2020 | | | |
| | | Revision | | | |
| | 27/07/2020 21/10/2020 | | | | |

| Display | | | |
|-----------------------|-------------------------|--------------|------------------|
| Resolution | 128 x 128 | | |
| Appearance | Black on White | | |
| Logic Voltage | 3V | | 1 |
| Interface | Parallel | | CoHS |
| Font Set | N/A | | UNS |
| Display Mode | Transflective | CC CC | ompliant |
| LC Туре 🦳 | FSTN | | |
| Module Size | 60.00 x 62.79 x 8.60 mm | | |
| Operating Temperature | -20°C ~ +70°C | | |
| Construction | COB | Box Quantity | Weight / Display |
| LED Backlight | White | | |

DESIGN • MANUFACTURE • SUPPLY * - For full design functionality, please use this

* - For full design functionality, please use this specification in conjunction with the ST75161 specification. (Provided Separately)

| Display Accessories | | | | | | |
|---------------------|---|--|--|--|--|--|
| Part Number | Description | | | | | |
| MDIB-CC1 | The MDIB-CC1 is a interconnect board for standard pitch pinouts to fine pitch wires. Ideal for prototyping of TFT and COG LCDs. | | | | | |
| | | | | | | |
| | | | | | | |

| Optional Variants | | | | | | | |
|-------------------|--|--|--|--|--|--|--|
| Appearances Volta | | | | | | | |
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General Specification

The Features is described as follow:

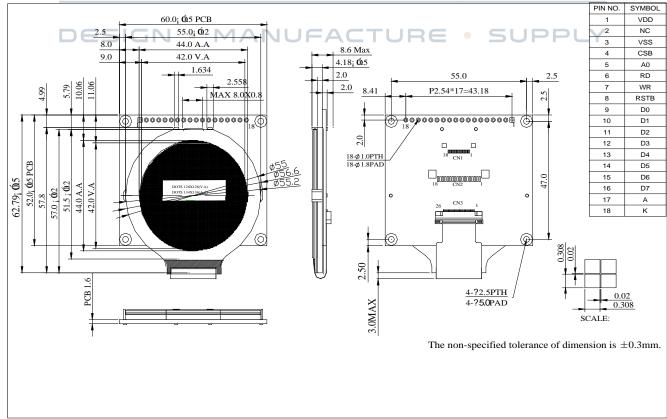
- Number of dots: 128 x 128
- Module dimension: 60.0 x 62.79 x 8.6 mm
- View area: 42.0 x 42.0 mm
- Active area: 44.0 x 44.0 mm
- Dot size: 0.308 x 0.308 mm
- Dot pitch: 0.328 x 0.328 mm
- LCD type: FSTN Positive Transflective
- Duty: 1/136 Duty, 1/12 Bias
- View direction: 6 o'clock
- Backlight Type: LED White
- IC: ST75161
- Interface: 8080

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Interface Pin Function

| Pin No. | Symbol | Function |
|---------|--------|---|
| 1 | VDD | Power supply |
| 2 | NC | No Connection |
| 3 | VSS | Ground |
| 4 | CSB | Chip select input pin. |
| 5 | A0 | It determines whether the access is related to data or command. |
| 6 | RD | Read / Write execution control pin. |
| 7 | WR | Read / Write execution control pin. |
| 8 | RSTB | Hardware reset input pin |
| 9-16 | D0-D7 | 8 bit bi-directional data bus |
| 17 | A | Anode input for LED backlight. |
| 18 | K | Cathode input for LED backlight |

Contour Drawing

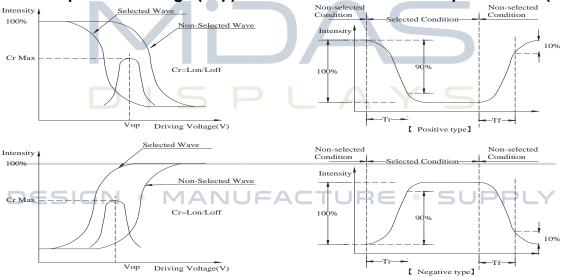


Optical Characteristics

| ltem | Symbol | Condition | Min | Тур | Max | Unit |
|----------------|--------|-----------|-----|-----|-----|---------|
| | θ | CR≧2 | 25 | 30 | _ | ψ= 180° |
| | θ | CR≧2 | 35 | 40 | _ | ψ= 0° |
| View Angle | θ | CR≧2 | 35 | 40 | — | ψ= 90° |
| | θ | CR≧2 | 25 | 30 | — | ψ= 270° |
| Contrast Ratio | CR | _ | 3 | 4 | _ | — |
| | T rise | _ | | 150 | 225 | ms |
| Response Time | T fall | | _ | 220 | 330 | ms |

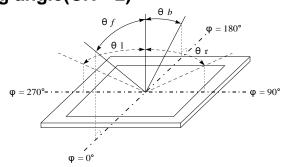
Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)



Conditions :

Operating Voltage : Vop Viewing Angle(θ , ϕ) : 0°, 0° Frame Frequency : 64 HZ Driving Waveform : 1/N duty, 1/a bias **Definition of viewing angle(CR \ge 2)**



Absolute Maximum Ratings

| Item | Symbol | Min | Тур | Max | Unit |
|--------------------------|--------|------|-----|---------|------|
| Operating Temperature | Тор | -20 | _ | +70 | °C |
| Storage Temperature | Тѕт | -30 | _ | +80 | °C |
| Power Supply Voltage | VDD | -0.3 | _ | 4.0 | V |
| LCD Power supply voltage | VLCD | -0.3 | _ | 20 | V |
| LCD Power supply voltage | V0-XV0 | -0.3 | | 19 | V |
| Input voltage | VIN | -0.3 | | VDD+0.3 | V |

Electrical Characteristics

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit |
|--------------------------|-----------------|-----------------------|---------------------|-------------|---------------------|------|
| Supply Voltage For Logic | VDD-Vss | J | 2.7 | 3.0 | 3.3 | V |
| | | Ta=-20 ℃ | | _ | _ | V |
| Supply Voltage For LCD | | Ta=25℃ | IR ^{13.7} | <u>14.0</u> | 14.3 | V |
| | | Ta=70 ℃ | | _ | _ | V |
| Input High Volt. | VIH | | 0.7 V _{DD} | _ | V _{DD} | V |
| Input Low Volt. | VIL | | Vss | _ | 0.3 V _{DD} | V |
| Output High Volt. | Vон | | 0.8 Vdd | _ | Vdd | V |
| Output Low Volt. | Vol | | Vss | _ | 0.2 V _{DD} | V |
| Supply Current | I _{DD} | V _{DD} =3.0V | _ | 2.0 | _ | mA |

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

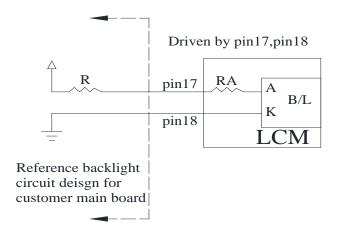
Backlight Information

Specification

| Parameter | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|--------|------|------|------|-------|--|
| Supply Current | ILED | 36 | 48 | 60 | mA | V=3.5V |
| Supply Voltage | V | _ | 3.5 | _ | v | _ |
| Reverse Voltage | VR | _ | _ | 5 | v | — |
| Chromaticity | Х | 0.25 | 0.27 | 0.30 | _ | — |
| Coordinates | Y | 0.25 | 0.27 | 0.30 | _ | — |
| Luminance (Without LCD) | IV | 800 | 1000 | | cd/m² | V=3.5V |
| LED Life Time (For Reference only) | P | - | 50K |)/ | Hr. | ILED=48mA 25℃,50-60%RH, (Note 1) |
| Color | White | 5 | P | | Α | Y 5 |

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.



Reliability

Content of Reliability Test (Wide temperature, -20℃~70℃)

| | Environmental Test | | |
|---------------------------------------|--|--|----------|
| Test Item | Content of Test | Test Condition | Not e |
| High Temperature storage | Endurance test applying the high storage temperature for a long time. | 80℃ 96hrs | 2 |
| Low Temperature storage | Endurance test applying the low storage temperature for a long time. | -30℃ 96hrs | 1,2 |
| High Temperature Operation | Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time. | 70℃ 96hrs | |
| Low Temperature Operation | Endurance test applying the electric stress under low temperature for a long time. | -20℃ 96hrs | 1 |
| High Temperature/ Humidity storage | The module should be allowed to stand at 40 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature. | 40℃,90%RH 96hrs | 1,2 |
| Thermal shock resistance | The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle | -20℃/70℃ 10 cycles | |
| DESIGN | - | Total fixed LY amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes | 3 |
| Static electricity test | Endurance test applying the electric stress to the terminal. | VS=±600V(contact) , | |

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

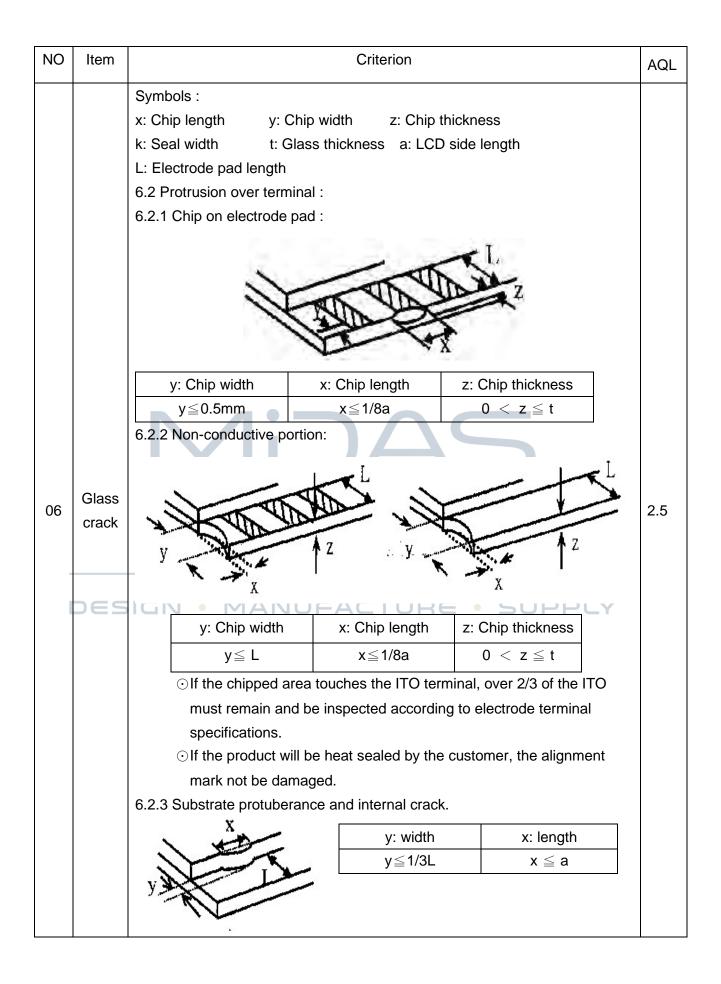
Note3: The packing have to including into the vibration testing.

Inspection specification

| NO | Item | | | Criterion | | AQL |
|----|--|--|---|---|---|-----|
| 01 | Electrical Testing | 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. | | | | |
| 02 | Black or white spots on LCD (display only) | 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm | | | | 2.5 |
| 03 | LCD black spots, white spots, contamination | 3.1 Round type Φ=(x + y) / | 2 | SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ | Acceptable Q TY Accept no dense 2 1 0 SUPPLY | 2.5 |
| | (non-display) | 3.2 Line type : (<i>i</i> | As followin Length L≦3.0 L≦2.5 | g drawing) Width W≦0.02 0.02 <w≦0.03 0.03<w≦0.05 0.05<w< td=""><td>Acceptable Q TY Accept no dense 2 As round type</td><td>2.5</td></w<></w≦0.05 </w≦0.03 | Acceptable Q TY Accept no dense 2 As round type | 2.5 |

| | | If bubbles are visible, | Size Φ | Acceptable Q TY | |
|----|--------------------|--|---|--------------------------|---|
| | | judge using black spot | Ф≦0.20 | Accept no dense | |
| 04 | Polarizer | specifications, not easy | $0.20 \! < \! \Phi \! \le \! 0.50$ | 3 | 2.5 |
| | bubbles | to find, must check in | $0.50 \! < \! \Phi \! \le \! 1.00$ | 2 | 2.0 |
| | | specify direction. | <u>1.00<Ф</u> | 0 | |
| | | | Total Q TY | 3 | |
| 05 | Scratches F | l ollow NO.3 LCD black spo | | | <u> </u> |
| 05 | | · · · · · · | is, white spots, conta | | |
| | x k L 6 | | width z: Chip the sthickness a: LCD and crack between | side length | |
| | Chipped | z: Chip thickness Z≦1/2t | y: Chip width ot over viewing | x: Chip length x≦1/8a | |
| 06 | Chipped N glass | • MANOFA | area | SUPPLY | 2.5 |
| | giuco | 1/2t <z≦2t n<="" td=""><td>lot exceed 1/3k</td><td>x≦1/8a</td><td></td></z≦2t> | lot exceed 1/3k | x≦1/8a | |
| | | If there are 2 or more chip | s, x is total length of | f each chip. | |
| | 6 | .1.2 Corner crack: | X | y | |
| | | z: Chip thickness | y: Chip width | x: Chip length | ן |
| | | | ot over viewing area | x≦1/8a | |
| | | 1/2t <z≦2t n<="" td=""><td>lot exceed 1/3k</td><td>x≦1/8a</td><td>1 </td></z≦2t> | lot exceed 1/3k | x≦1/8a | 1 |
| | | If there are 2 or more chip | s, x is the total lengt | th of each chip. | J |
| | | | | Page 9 | I |

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| NO | Item | Criterion | AQL | | | | |
|----|-----------------------|---|-------------|--|--|--|--|
| 07 | Cracked glass | The LCD with extensive crack is not acceptable. | | | | | |
| 08 | Backlight elements | 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. | | | | | |
| 09 | Bezel | 9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications. | 2.5 0.65 | | | | |
| | | 10.1 COB seal may not have pinholes larger than 0.2mm or contamination.10.2 COB seal surface may not have pinholes through to the | 2.5 | | | | |
| | | IC. | 2.5 | | | | |
| | | 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. | 0.65 | | | | |
| | | 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. | 2.5 | | | | |
| | D | 10.5 No oxidation or contamination PCB terminals. | 2.5 | | | | |
| 10 | PCB \ COB | 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, | | | | | |
| C | DESIGN | missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. | 0.65 | | | | |
| | | 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or | | | | | |
| | | screw hold pad, make sure it is smoothed down. | 2.5 | | | | |
| | | 10.9 The Scraping testing standard for Copper Coating of PCB | 2.5 | | | | |
| | | Y X * Y<=2mm2 | | | | | |
| 11 | | 11.1 No un-melted solder paste may be present on the PCB. | 2.5 | | | | |
| | Soldarian | 11.2 No cold solder joints, missing solder connections, oxidation or icicle. | 2.5 | | | | |
| | Soldering | 11.3 No residue or solder balls on PCB. | 2.5 | | | | |
| | | 11.4 No short circuits in components on PCB. | 0.65 | | | | |

| NO | Item | Criterion | AQL | | |
|----------|-------------------------------|--|--|--|--|
| NO 12 | Item General appearance | Criterion 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. | 2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 | | |
| | | 12.8 Pin type must match type in specification sheet.12.9 LCD pin loose or missing pins. | 0.65 0.65 | | |
| | | 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. | | | |
| | | 12.12 Visual defect outside of VA is not considered to be rejection. | | | |

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Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas Displays have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas Displays have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas Displays have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

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Material List of Components for RoHs

 Midas Displays hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

| Material | Cd | Pb | Hg | Cr6+ | PBB | PBDE | DEHP | BBP | DBP | DIBP |
|--|-----|------|------|------|------|------|------|------|------|------|
| Limited | 100 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 |
| Value | ppm | ppm | ppm | ppm | ppm | ppm | ppm | ppm | ppm | ppm |
| Above limited value is set up according to RoHS. | | | | | | | | | | |

2. Process for RoHS requirement : (only for RoHS inspection)

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow : 250°C,30 seconds Max. ;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.